

# PRODUCT SPECIFICATION

*Part Number*  
**PAC100-CxDxxx**

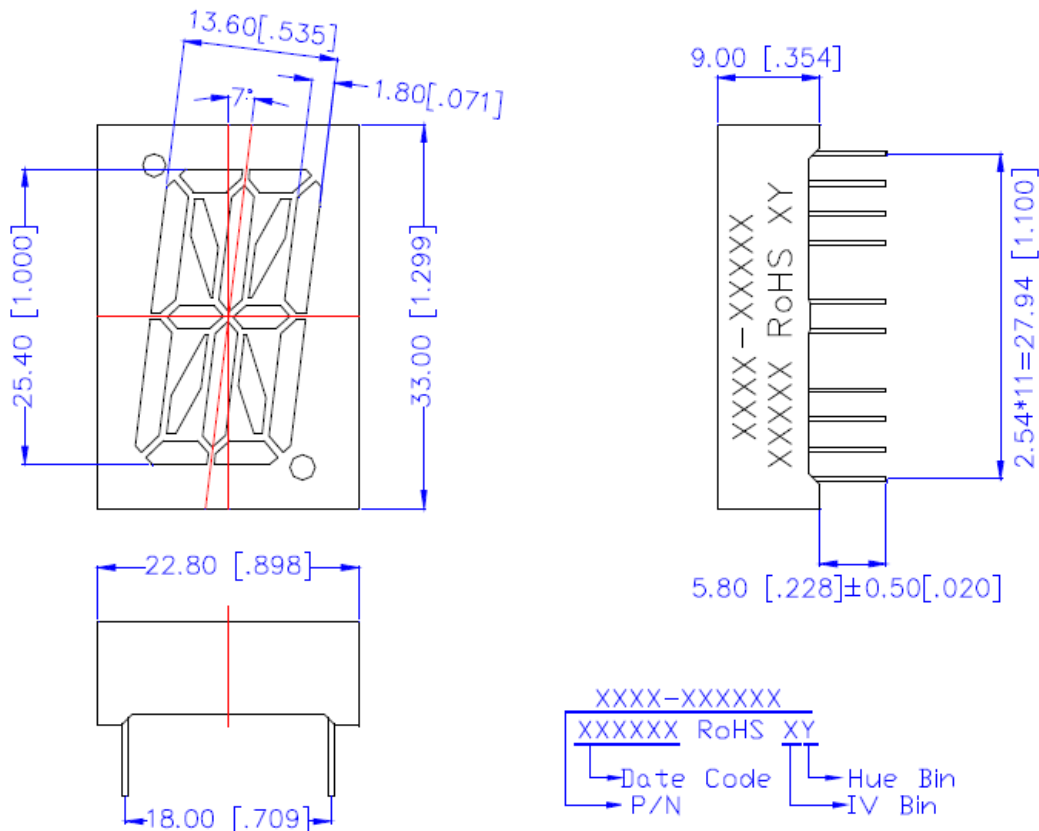
## Details

- 1.0" (25.4mm) Display
- 1 Digit, Alphanumeric
- Common Anode or Cathode
- AlInGaP or InGaN dice used

## Features

- Low power consumption
- RoHS Compliant
- Gray Face, White Segments or Black Face, White Segments
- Easy mounting on PCB or socket

## Mechanical Dimensions



### Notes:

1. Dimensions in millimeters [inch], and tolerance is  $\pm 0.25$  [.010] and angle is  $\pm 1^\circ$  unless otherwise noted.
2. Bending  $\leq$  Length\*1%
3. All pins are  $\text{Ø}0.510$  [.020]  $\pm 0.1$  [.004]
4. Specifications subject to change without notice



**Device Selection Guide**

Model Number	Chip		Description	Note
	Material	Emitting Color		
PAC100-CxDG05	InGaN	True Green	Common Cathode x=C / Common Anode x=A	Add "BFWS" to end of part number for Black Face, White Segment version
PAC100-CxDG17	AlInGaP	Yellow Green		
PAC100-CxDY04		Yellow		
PAC100-CxDA11		Amber		
PAC100-CxDR02		Orange-Red		
PAC100-CxDR11		Red		
PAC100-CxDR21		Deep Red		

**Absolute Maximum Ratings at Ta=25°C**

Parameter	Symbol	Rating		Unit
		G17/Y04/A11/R02/R11/R21	G05	
Power Dissipation per Dice	PAD	70	114	mW
Derating Liner from 25°C per Dice	--	0.33	0.4	mA/°C
Continuous Forward Current Per Dice	IAF	25	30	mA
Peak Current Per Dice (duty cycle 1/10, 1KHz)	IPF	90	100	mA
Reverse Voltage Per Dice	VR	5	5	V
Electrostatic Discharge (HBM)	ESD	/	1000	V
Operating Temperature	Topr	-35~+85		°C
Storage Temperature	Tstg	-35~+85		°C

Solder Conditions: 1/16 inch below seating plane for 3 -5 seconds at 260°C.

**Electrical and Optical Characteristics at Ta=25°C**

Parameter	Symbol	Chip	Min.	Typ.	Max.	Unit	Condition
Forward Voltage Per Segment	VF	G05	--	6.4(3.2)	7.6(3.8)	V	IF=20mA
		G17/Y04/A11/R02/R11/R21	--	4(2)	5.6(2.8)		
Luminous Intensity Per Segment	Iv	G05	--	576	--	mcd	IF=10mA
		G17	--	32	--		
		Y04	--	137	--		
		A11	--	181	--		
		R02	--	88	--		
		R11	--	60	--		
Peak Emission Wavelength / Dominant Wavelength	$\lambda P/\lambda d$	G05	--	*525	--	nm	IF=20mA
		G17	--	572/570	--		
		Y04	--	592/590	--		
		A11	--	612/605	--		
		R02	--	632/625	--		
		R11	--	644/630	--		
Reverse Current	IR		--	--	100	$\mu$ A	VR=10(5)V
Luminous Intensity Matching Ratio	Iv-m		--	--	2:1	--	IF=10mA

### Typical Electrical/Optical Characteristic Curves

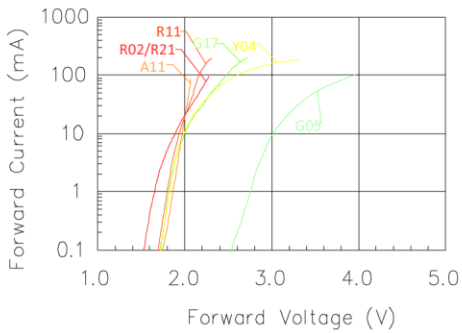


Fig 1. Forward Current vs. Forward Voltage

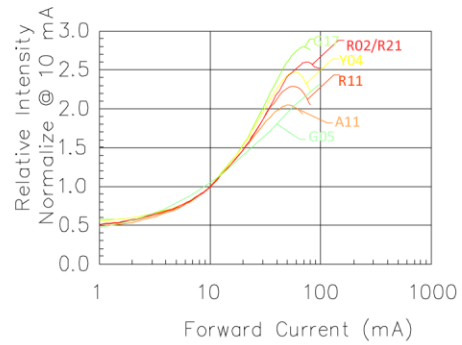


Fig 2. Relative Intensity vs. Forward Current

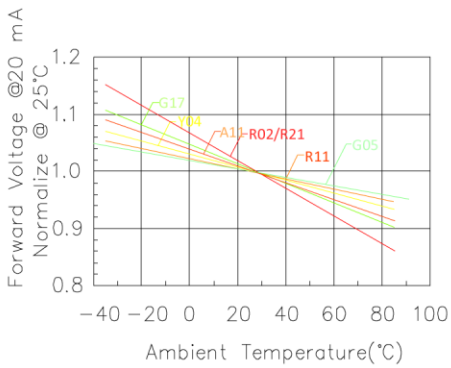


Fig 3. Forward Voltage vs. Temperature

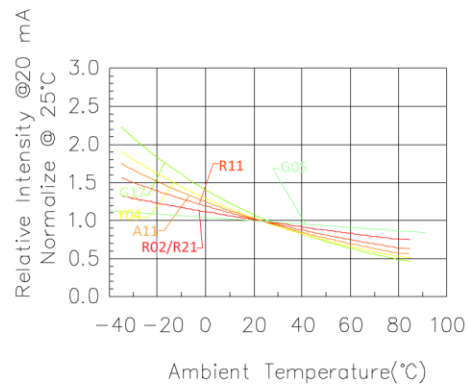


Fig 4. Relative Intensity vs. Temperature

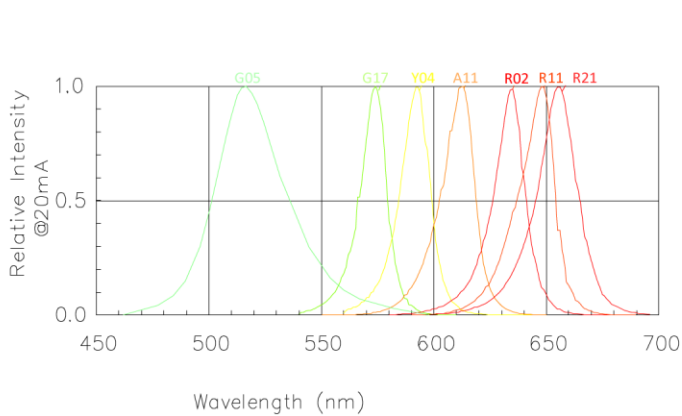


Fig 5. Relative Intensity vs. Wavelength

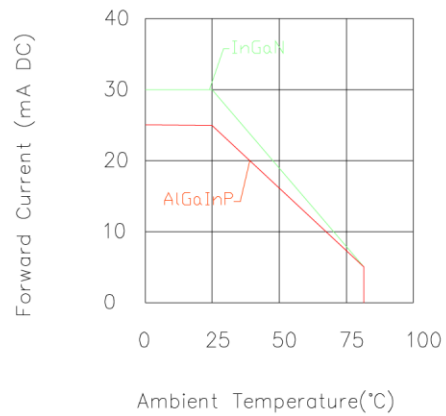


Fig 3. Forward Current vs. Ambient Temperature

**Luminous General lv Bin Grade (IF = 10mA)**
**■ Luminous General lv Bin Grade (IF = 10mA)**
**Color Rank Limits (IF = 20mA)**

Remark: Unit=mcd

\*Tolerance: ±20%

Remark: Unit=nm

\*Tolerance: ±1

**● Pure Green(G02)**

S	T	U
288.997	462.397	739.836
462.396	739.835	1183.737

1	2	3	4	5
515.0	518.0	520.0	522.0	524.0
518.0	520.0	522.0	524.0	527.0

**● Yellow Green(G17)**

L	M	N
17.224	27.559	44.096
27.558	44.095	70.554

0	1	2	3	4
567.5	569.5	570.5	571.5	573.0
569.5	570.5	571.5	573.0	575.0

**● Yellow (Y04)**

P	Q	R
70.555	112.889	180.623
112.888	180.622	288.996

1	2	3	4	5
583.0	585.0	587.0	589.0	591.0
585.0	587.0	589.0	591.0	593.0

**● Amber (A11)**

Q	R	S
112.889	180.623	288.997
180.622	288.996	462.396

**● Orange (R02)**

N	P	Q
44.096	70.555	112.889
70.554	112.888	180.622

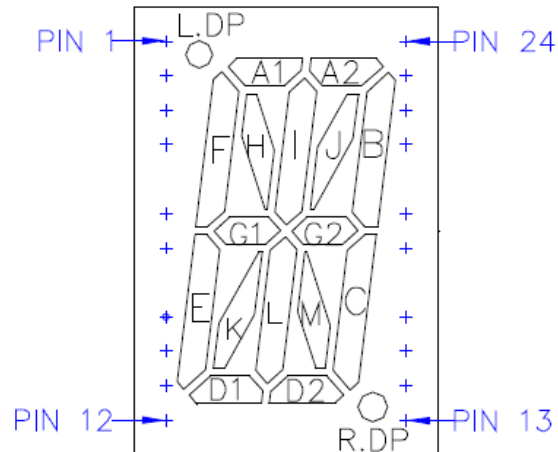
**● Red (R11)**

M	N	P
27.559	44.096	70.555
44.095	70.554	112.888

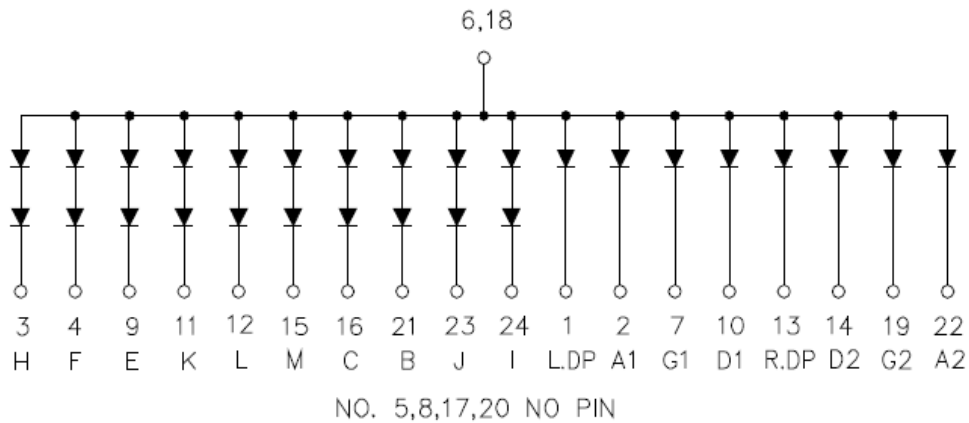
**● Deep Red(R21)**

M	N	P
27.559	44.096	70.555
44.095	70.554	112.888

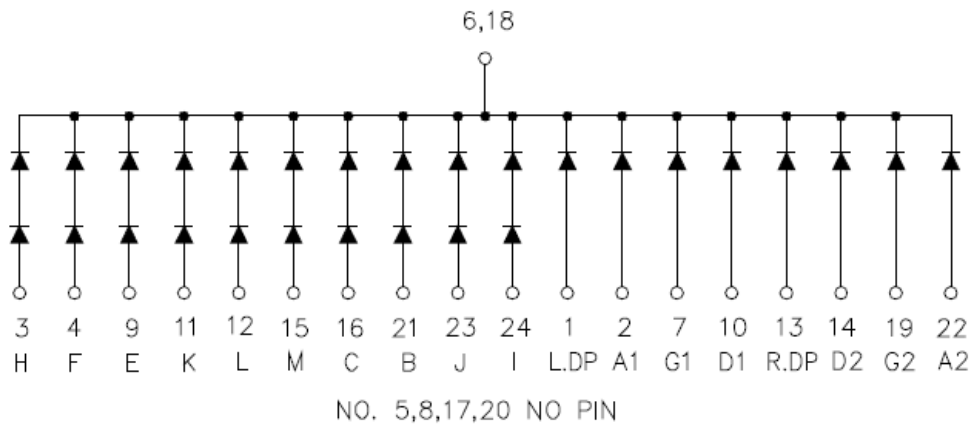
**All Light-On Segments Feature & Pad Position**



**Internal Circuit Diagram**



**Common Anode**



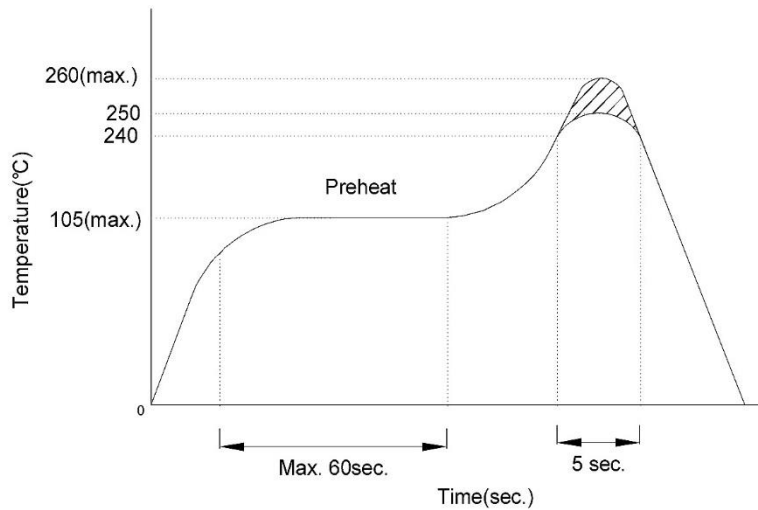
## Common Cathode

### *Precautions for Use*

#### 1. Recommended soldering conditions

##### 1.1. Wave soldering

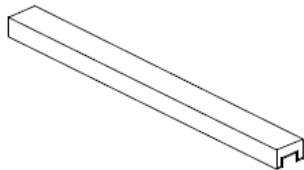
Basic SPEC is  $\leq 5$ sec. When  $260^{\circ}\text{C}$ . If temperature is higher, time should be shorter ( $+10^{\circ}\text{C} \rightarrow -1$ sec.).



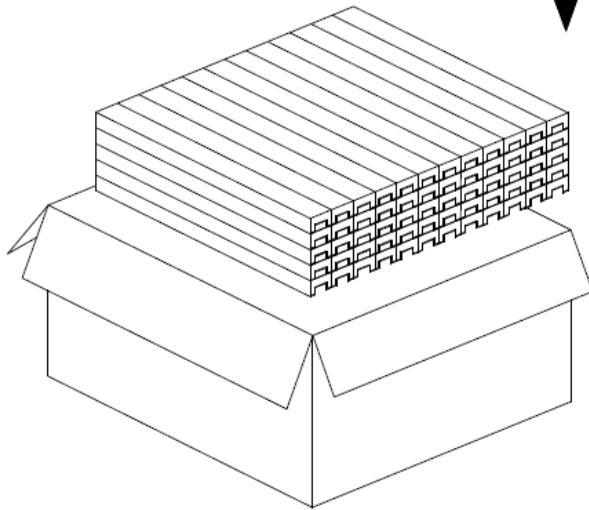
##### 1.2. Soldering Iron:

Power dissipation of iron should be smaller than 15W and temp should be controllable. Soldering temperature should be under  $260^{\circ}\text{C}$ , time  $\leq 3$ sec.

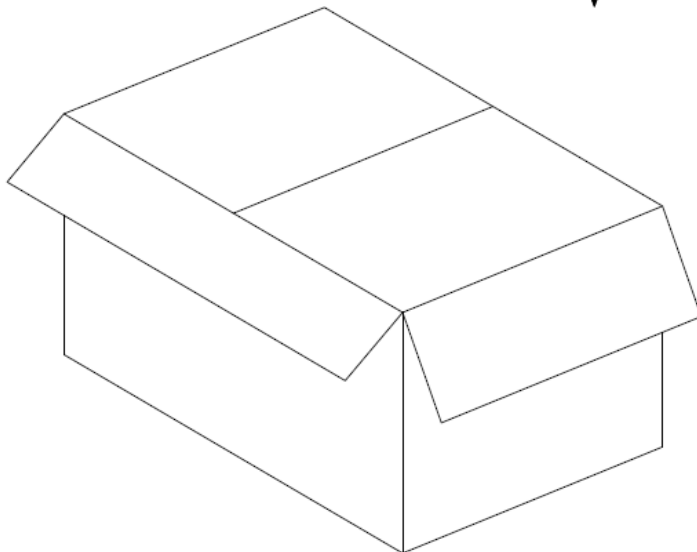
***Packing Dimensions***



15 PCS Per Tube  
Tube Size:  
L520\*W38\*H21 mm



42 Tubes Per Inner Box  
Total Q'TY: 630 Pcs  
Box Size:  
L530\*W265\*H155 mm



2 Inner Boxes Per Carton.  
Total Q'TY: 1260 Pcs  
Box Size:  
L540\*W345\*H290 mm





Note: 1. Specifications subject to change without notice.

Customer Approval Signatures	Approved By	Checked By	Prepared By

Record Of Revisions			
Rev.	Comments	Page	Date
0	Released Spec	--	11/12/13
1	Logo Update	All	04/07/15